FOR OFFICIAL USE		
Application No:		

Please paste a photo facing straight at the camera and taken within 3 months

APPLICATION FOR ADMISSION

	ILISH ENGINEERIN TE SCHOOL OF EN	IG EDUCATION PROGRAM (NGINEERING	(e³)		
HOKKAI	OO UNIVERSITY				
	R'S PROGRAM RAL PROGRAM				
Desired enro	olment: April 20	October 20			
letters. Attach al Unclear	ype in the application. If ha	ndwriting, please write neatly in capital of specified in the list of application docurrithout proper explanation will not be con	ments.	□Male □Female □Single □Married	
Surna	ame/Family name	First name	Mi	iddle name	
(2-1) Nationa	ality	(2-2) Do you possess Jap	anese natio	onality? □ Yes, I do. □ No, I don't.	
(3) Date of B	Birth (DD/MM/YYYY)				
(4) Current A	Address				
Zip code:		Address:			
Phone		E-mail			
	ncements will be sent by e- or the whole period of your	mail. Please make sure to provide a cor application.	rect and vali	d e-mail address which	
(5) Permane	nt Address				
Zip code:		Address:			
Phone	hone E-mail				
	lown the names of one or	two faculty members (professors/assoc ou want to be considered for admission (
	Professor's name	Name of the Laboratory	Division	/	
1 st choice		Laboratory of			
2 nd choice		Laboratory of			

 $\hfill \square$ I agree to be considered for acceptance by a different supervisor/laboratory.

(7)	The	Title	of	Research	Proposal
<i></i>					

Please write down the title of your planned research and attach a research proposal (in details if you are applying for a doctoral program). If the two professors or laboratories you have chosen deal with different research topics, please write down two research tittles, and attach two corresponding proposals.

(i)

(ii)

(8) Educational Background

You shall prepare official academic transcripts (complete or the most recent by the time of your application if your study is still in progress) and your graduation or expected graduation certificate. If your rank is not indicated therein, an official ranking certificate is necessary.

If you have spent a semester or more on exchange program in another university, currently enrolled as research student, have additional qualifications etc. please specify it in the section "others"

	Institution, Name of the University	Major Field	Period of enrollment (month/year)	Type of Diploma/ Degree awarded	Final Grade (GPA)	Rank in Class if any (rank/total students)
Bachelor's			from /			
Master's			From /			
Others			From / to /			

(9) Employment Record Please begin with the most recent employment.

Organization, city, country	Period of employment (month/year)	Position	Type of work, brief description
	From / to /		
	From / to /		

(10) List of Publications and Graduation Thesis

If you have any publications please write down a full reference information including the name(s) of the author(s), title, publisher, date of publication, pages. When DOI is available, please include it. Attach abstracts and/or reprints.

Bachelor's thesis title:

Master's thesis title:

List of publications (If the list is too long, please attach a separate sheet):

1	
2	
3	

(11) I	English	Profici	ency
--------	----------------	----------------	------

Please attach a score certificate or a medium of instruction certificate.

TOEFL, IELTS, TOEIC or other standardized English test score obtained within two years.

Test	Score		Date take	en (DD/MM/YYYY)
☐ I have requested my TOEFL/IELTS For applicants who completed full ☐ I completed a full-time degree progran ☐ I am a native speaker of English. (12) Have you been awarded an If yes, please provide the details	time degree in Englis n which language of instru ny scholarship, gran	sh and/or uction was l	are native s English.	peakers:
The name of scholarship, grant, award,	Awarding organization/	Peri	ind	Explain briefly about the
prize etc	fund	(month		scholarship, etc.
		From	/	
		to	,	
		From	/	
		to	1	
☐ Yes (Please fill in the details below) University	Scholarship/Grant		Country	Expected date of the results announcement
□ No (14) How do you plan to support □ I'm applying for or was awarded a s □ Japanese government (MEXT □ Japanese government (MEXT □ Please specify the type: □ Chinese Council Scholarship □ JICA Scholarship □ Please specify the type: □ Other (please specify the deta	cholarship/educational I) scholarship (Embassy) scholarship (Other). CSC)	oan: recommer	ndation)	
Name of the scholarship (loan), organization	Status of the application apply/nominated, etc)	(going to	Application deadline	Expected date of the results announcement
(Please attach the scholarship information	tion form and if already	nominated	l a confirmati	on letter)
☐ will primarily bare all the expenses I Please attach the international application didn't succeed please tick the Scholarship, tuition fee discount/waiver☐ Other (specify)	by myself/ will be supportant's declaration of Finits option too. Self-funder	rted by a spance. If you	ponsor (even ou wish to er ts may qualify	if not awarded a scholarship). Iroll even if your scholarship If or such a support as Honors

(15) Referees

You shall request for the recommendation letters by yourself. If it's not attached to your application please tick the relevant box. Please make sure that the recommendation letters sent by referees directly to the program's office can arrive before the deadline.

(i) Name:☐ I have requested the referee to send the letter di	Position:	E-mail:
(ii) Name:	Position:	E-mail:
☐ I have requested the referee to send the letter di	rectly to the program's office.	
(16) How did you know about our program We would appreciate if you not only tick a box, but a		
☐1.e3 home page	□2.Met professors/students from	
☐3.During an internship/exchange program at HU ☐5.Was advised by peers/senior students	□4.Was advised by the supervis□6.Saw a brochure/announcem	
□7.At a study abroad/ study in Japan fair etc.	☐8.Checked related to study about	-
□9.Other		
Additional details:		
(17) Contact person in your home country	1	
Name:	Relationship with you:	
Address:		
Tel/Fax:	E-mail:	

Signature Date submitted Postal address for submitting the application documents: English Engineering Education program (e3) International Affairs Office of Engineering (A1-58) Graduate School of Engineering Hokkaido University Kita 13 Nishi 8, Kita-ku Sapporo 060-8628, Japan TEL:81-11-706-8089 FOR OFFICIAL USE To be filled out by professor who accepts the applicant I would like to accept this applicant as a master/doctoral student under my supervision. During the applicant's enrolment I will act as his/her contact person in Japan in case he/she is involved in some incidents and accidents. Name: Laboratory: Signature: Date: Part II To be signed by Chairman of the Division the above professor belongs to after the applicant is accepted by the professor above. I agree to allow this applicant to be considered for enrolment in the Division.

Date:

I understand that withholding pertinent information requested in this application form or giving false information will

make me ineligible for admission or liable for dismissal.

Name:

Division:

Signature: